Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

Slotted Interrupter
Version 1.3

SFH 9540

Features:

- Suitable for surface mounting (SMT)
- Compact housing out of black LCP
- GaAs infrared emitter (950 nm)
- Silicon phototransistor with daylight-cutoff filter
- With positioning pin
- Suitable for pick and place
- High sensing accuracy (slit width: 0.5 mm)
- Wide gap between emitter and detector (5 mm)
- High stability on pcb due to large width of device (6.8 mm)

Applications

- Speed control
- Motor control
- Monitoring of paper feed in printers, copiers, facsimiles
- Control of print head in printers
- Coin detection
- Optoelectronic switches

Ordering Information

Type:	**Collector-emitter current** I_{PCE} [µA] **I_F = 20 mA, V_{CE} = 5 V**	**Ordering Code**
SFH 9540	≥ 1000	Q65111A6122

OSRAM Opto Semiconductors

Maximum Ratings (T_A = 25 °C)

Parameter	Symbol	Values	Unit
Emitter			
Reverse voltage	V_R	5	V
Forward current	I_F	60	mA
Power consumption	P_{tot}	100	mW
Thermal resistance junction - ambient [1] *page 10*	R_{thJA}	350	K / W
Detector			
Collector-emitter voltage	V_{CE}	30	V
Collector-emitter voltage (t ≤ 2 min)	V_{CE}	70	V
Emitter-collector voltage	V_{EC}	7	V
Collector current	I_C	50	mA
Total Power dissipation	P_{tot}	150	mW
Thermal resistance junction - ambient [1] *page 10*	R_{thJA}	350	K / W
Slotted Interrupter			
Operation temperature range	T_{op}	-40 ... 85	°C
Storage temperature range	T_{stg}	-40 ... 85	°C
Electrostatic discharge	V_{ESD}	2	kV
Thermal resistance junction - ambient	R_{thJA}	350	K / W

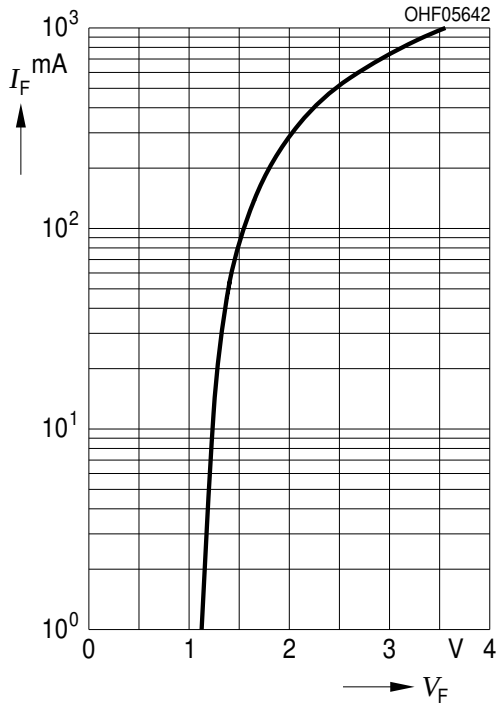
Characteristics (T_A = 25 °C)

Parameter		Symbol	Values	Unit
Emitter				
Peak wavelength (I_F = 20 mA, t_p = 20 ms)	(typ)	λ_{peak}	950	nm
Forward voltage (I_F = 20 mA, t_P = 20 ms)	(typ (max))	V_F	1.3 (≤ 1.6)	V
Reverse current (V_R = 5 V)		I_R	not designed for reverse operation	µA
Detector				
Wavelength of max. sensitivity	(typ)	$\lambda_{S\ max}$	920	nm

Parameter		Symbol	Values	Unit
Spectral range of sensitivity	(typ)	$\lambda_{10\%}$	(typ) 840 ... 1080	nm
Capacitance (V_{CE} = 0 V, f = 1 MHz, E = 0)	(typ)	C_{CE}	6.5	pF
Dark current (V_{CE} = 20 V)	(typ (max))	I_{CE0}	2 (≤ 50)	nA
Interrupter				
Collector-emitter current (I_F = 20 mA, V_{CE} = 5 V)	(min)	I_{PCE}	1000	µA
Collector-emitter saturation voltage (I_F = 20 mA, I_C = 0.3 mA)		V_{CEsat}	≤ 400	mV
Switching Times				
Rise time (V_{CC} = 5 V, I_C = 1 mA, R_L = 1 kΩ)	(typ)	t_r	13	µs
Fall time (V_{CC} = 5 V, I_C = 1 mA, R_L = 1 kΩ)	(typ)	t_f	17	µs

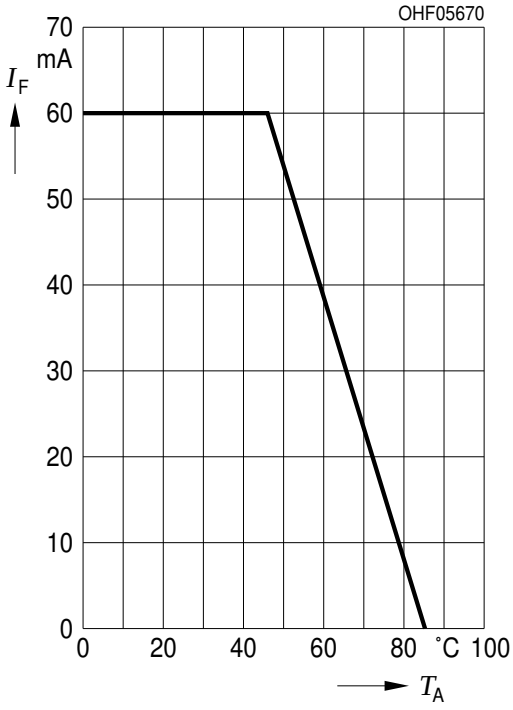
Forward Current 2) *page 10*

$I_F = f(V_F)$, single pulse, t_p = 100 µs, T_A = 25°C



Max. Permissible Forward Current

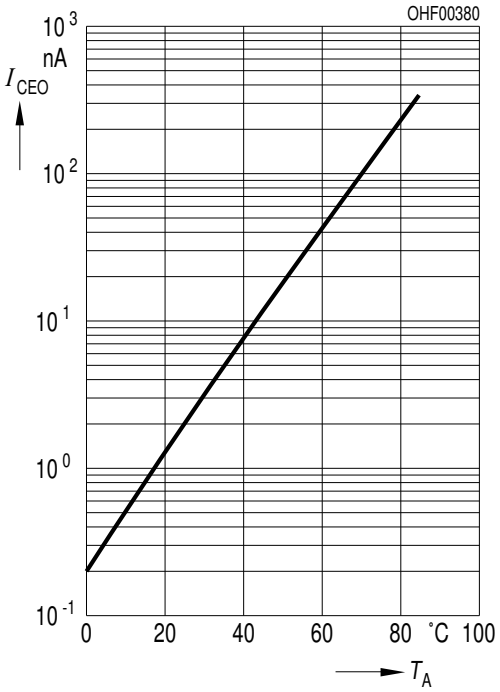
$I_{F, max} = f(T_A)$, R_{thJA} = 350 K / W



OSRAM Opto Semiconductors

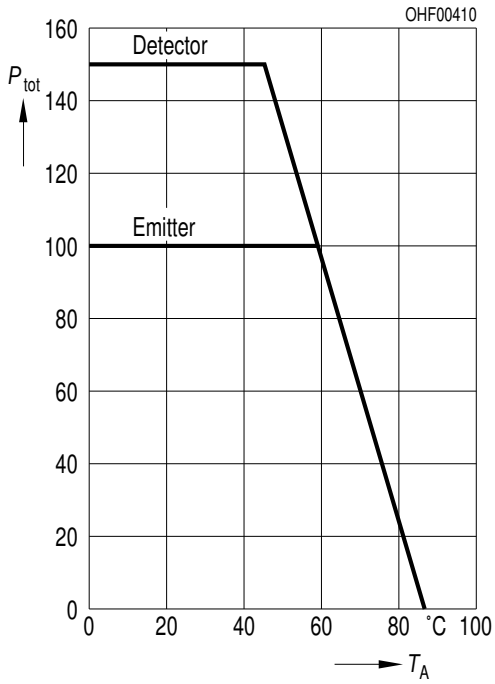
Dark Current 2) *page 10*

$I_{CEO} = f(T_A)$, V_{CE} = 20 V, E = 0



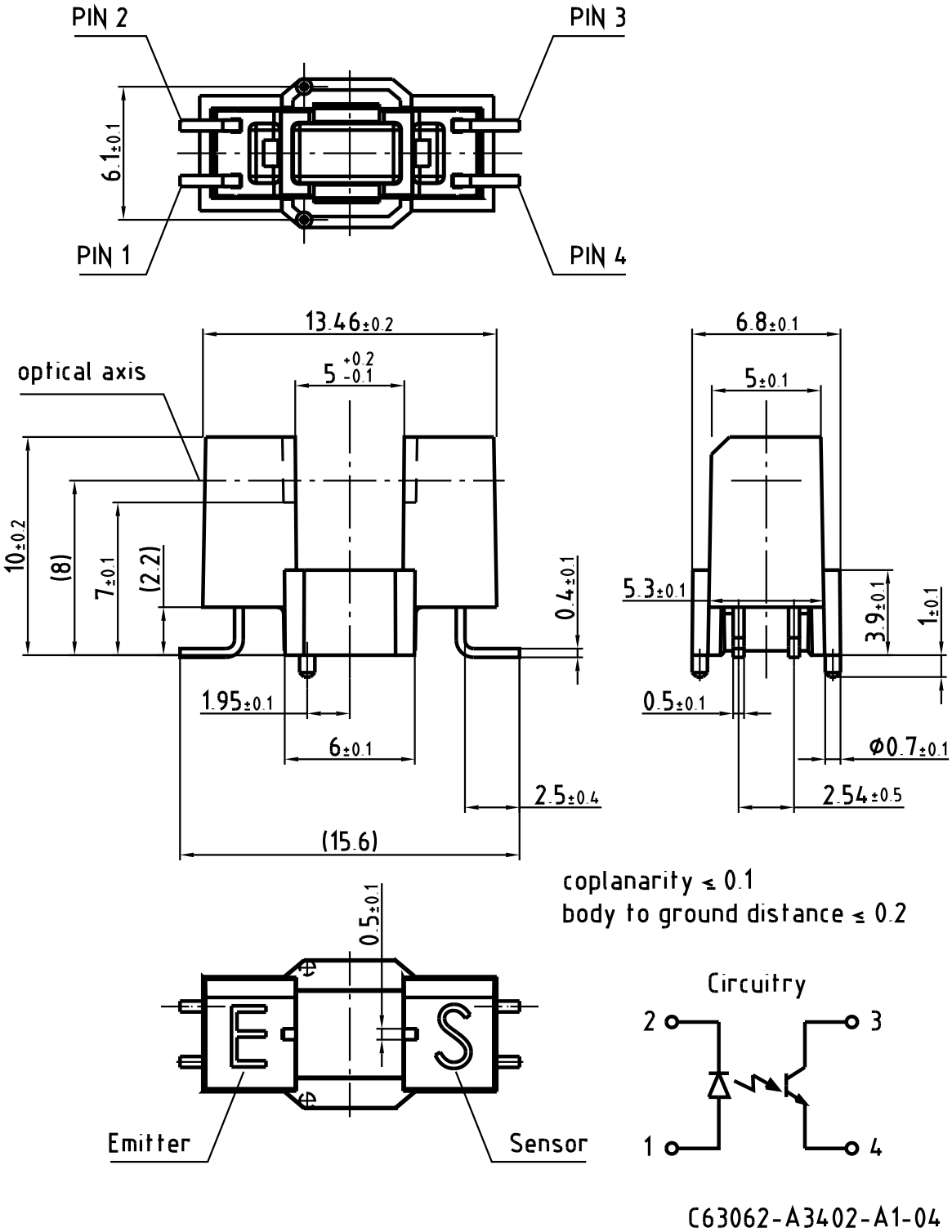
Power Consumption

$P_{tot} = f(T_A)$



OSRAM Opto Semiconductors

Package Outline



Dimensions in mm.

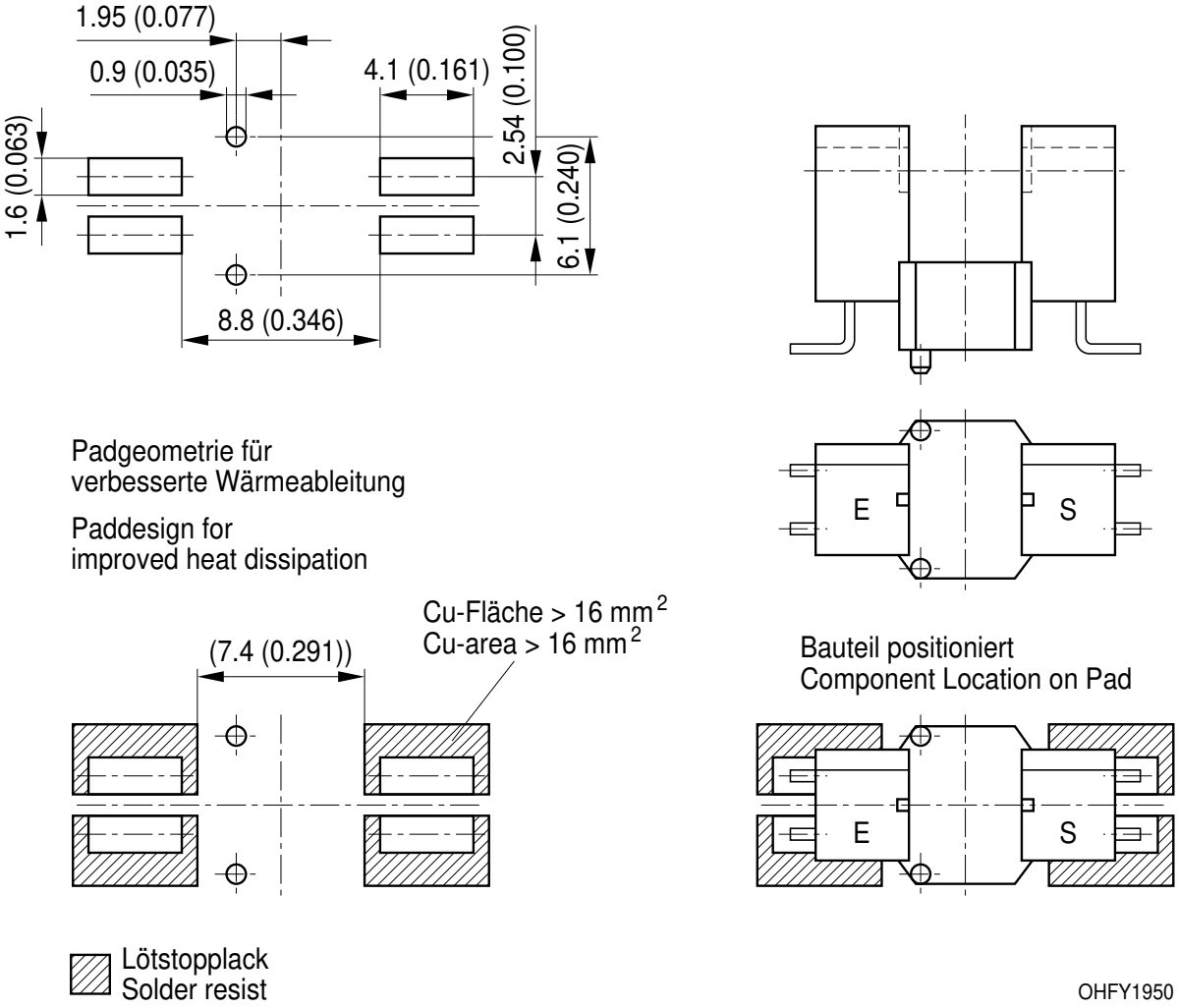
Pinning

Pin	Description
1	Emitter - Anode
2	Emitter - Cathode
3	Sensor - Collector
4	Sensor - Emitter

Package
Slotted Interrupter

Approximate Weight:
0.6 g

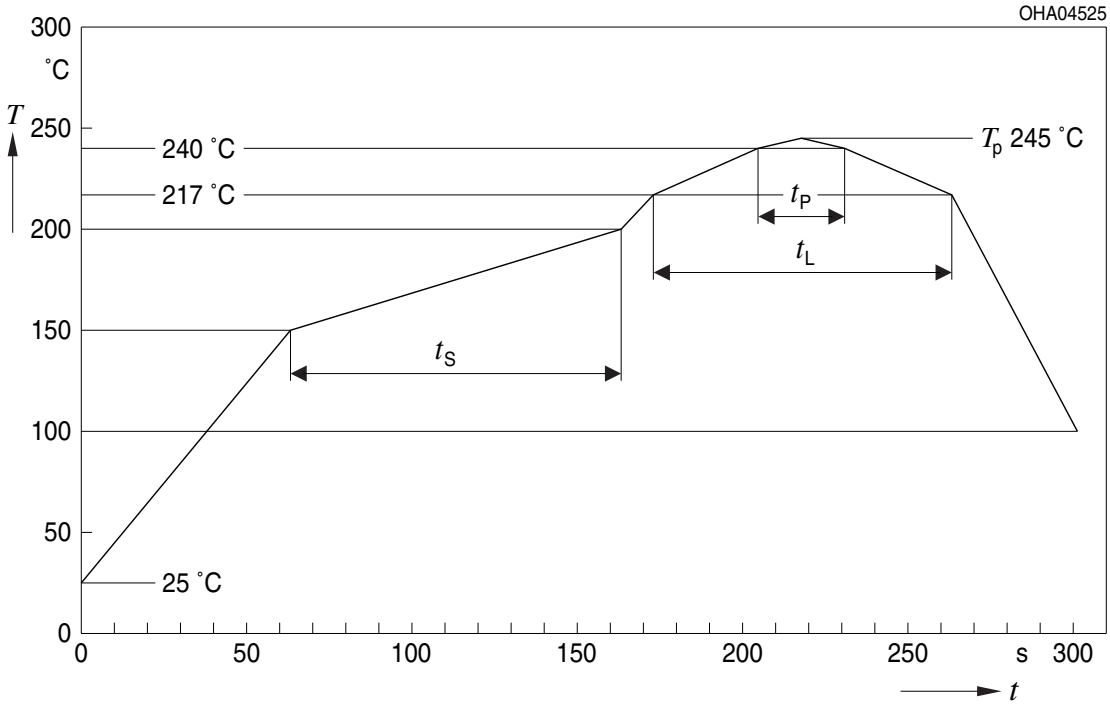
Recommended Solder Pad



Dimensions in mm (inch).

Reflow Soldering Profile

Product complies to MSL Level 1 acc. to JEDEC J-STD-020D.01



Profil-Charakteristik Profile Feature	Symbol Symbol	Pb-Free (SnAgCu) Assembly			Einheit Unit
		Minimum	Recommendation	Maximum	
Ramp-up Rate to Preheat*) 25 °C to 150 °C			2	3	K/s
Time t_S T_{Smin} to T_{Smax}	t_S	60	100	120	s
Ramp-up Rate to Peak*) T_{Smax} to T_P			2	3	K/s
Liquidus Temperature	T_L		217		°C
Time above Liquidus temperature	t_L		80	100	s
Peak Temperature	T_P		245	250	°C
Time within 5 °C of the specified peak temperature T_P - 5 K	t_P	10	20	30	s
Ramp-down Rate* T_P to 100 °C			3	4	K/s
Time 25 °C to T_P				480	s

All temperatures refer to the center of the package, measured on the top of the component

* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

Attention please!
The information describes the type of component and shall not be considered as assured characteristics.
Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.
For information on the types in question please contact our Sales Organization.
If printed or downloaded, please find the latest version in the Internet.
Packing
Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.
Components used in life-support devices or systems must be expressly authorized for such purpose!
Critical components* may only be used in life-support devices** or systems with the express written approval of OSRAM OS.

*) A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.
**) Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health and the life of the user may be endangered.

Glossary

[1] **Thermal resistance:** Mounting on PC-board with > 5 mm^2 pad size

[2] **Typical Values:** Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

Published by OSRAM Opto Semiconductors GmbH
Leibnizstraße 4, D-93055 Regensburg

EU RoHS and China RoHS compliant product

此产品符合欧盟 RoHS 指令的要求；

按照中国的相关法规和标准，不含有毒有害物质或元素。

OSRAM
Opto Semiconductors